

<u>1200V 30A</u> APT30DQ120KG*

*G Denotes RoHS Compliant, Pb Free Terminal Finish.

ULTRAFAST SOFT RECOVERY RECTIFIER DIODE

PRODUCT APPLICATIONS

- Anti-Parallel Diode -Switchmode Power Supply -Inverters
- Free Wheeling Diode -Motor Controllers -Converters -Inverters
- Snubber Diode

• PFC

Ultrafast Recovery Times

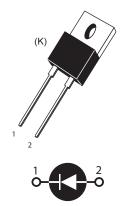
- Soft Recovery Characteristics
- Popular TO-220 Package

PRODUCT FEATURES

- · Low Forward Voltage
- · Low Leakage Current
- Avalanche Energy Rated

PRODUCT BENEFITS

- Low Losses
- Low Noise Switching
- Cooler Operation
- · Higher Reliability Systems
- Increased System Power Density



1 - Cathode 2 - Anode

Back of Case - Cathode

MAXIMUM RATINGS

All Ratings: $T_{C} = 25^{\circ}C$ unless otherwise specified. APT30DQ120K(G) UNIT Symbol **Characteristic / Test Conditions** V_R Maximum D.C. Reverse Voltage V_{RRM} 1200 Volts Maximum Peak Repetitive Reverse Voltage V_{RWM} Maximum Working Peak Reverse Voltage 30 I_{F(AV)} Maximum Average Forward Current ($T_c = 103^{\circ}C$, Duty Cycle = 0.5) 43 Amps I_{F(RMS)} RMS Forward Current (Square wave, 50% duty) 210 I_{FSM} Non-Repetitive Forward Surge Current (T₁ = 45°C, 8.3ms) $\mathsf{E}_{\mathsf{AVL}}$ 20 m.J Avalanche Energy (1A, 40mH) -55 to 175 T_J,T_{STG} Operating and StorageTemperature Range °C Τ_L 300 Lead Temperature for 10 Sec.

STATIC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions		MIN	ТҮР	MAX	UNIT
V _F	Forward Voltage	I _F = 30A		2.8	3.3	
		I _F = 60A		3.4		Volts
		I _F = 30A, T _J = 125°C		2.1		
I _{RM}	Maximum Reverse Leakage Current	V _R = 1200V			100	μA
		V _R = 1200V, T _J = 125°C			500	
C _T	Junction Capacitance, V _R = 200V			36		pF

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Microsemi Website - http://www.microsemi.com

DYNAMIC CHARACTERISTICS

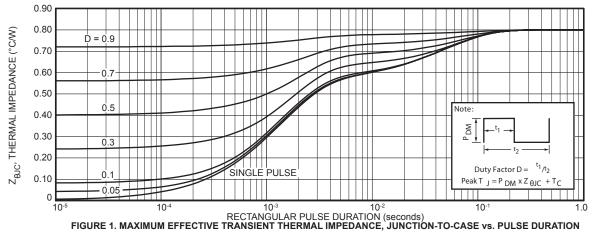
APT30DQ120K(G)

Symbol	Characteristic	Test Conditions	MIN	ТҮР	MAX	UNIT
t _{rr}	Reverse Recovery Time $I_F = 1A$, $di_F/dt = -100A/\mu s$, $V_R = 30V$, $T_J = 25^{\circ}C$		-	26		nc
t _{rr}	Reverse Recovery Time	I _F = 30A, di _F /dt = -200A/μs V _R = 667V, T _C = 25°C	-	320		ns
Q _{rr}	Reverse Recovery Charge		-	545		nC
I _{RRM}	Maximum Reverse Recovery Current		-	4	-	Amps
t _{rr}	Reverse Recovery Time	I _F = 30A, di _F /dt = -200A/μs V _R = 667V, T _C = 125°C	-	435		ns
Q _{rr}	Reverse Recovery Charge		-	2100		nC
I _{RRM}	Maximum Reverse Recovery Current		-	9	-	Amps
t _{rr}	Reverse Recovery Time	I _F = 30A, di _F /dt = -1000A/µs V _R = 667V, T _C = 125°C	-	180		ns
Q _{rr}	Reverse Recovery Charge		-	2975		nC
I _{RRM}	Maximum Reverse Recovery Current		-	28		Amps

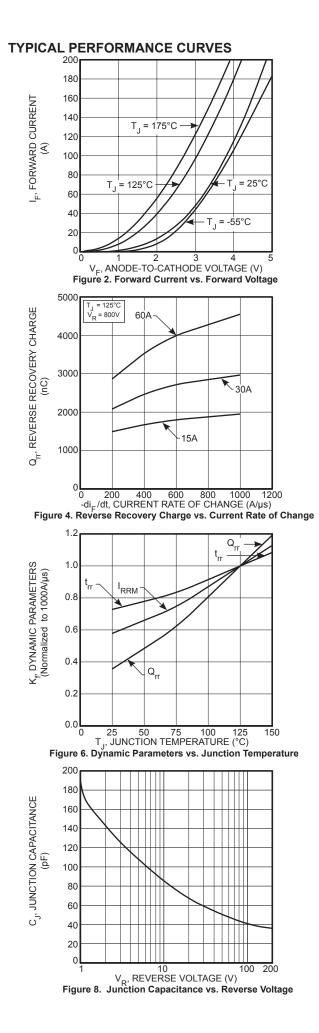
THERMAL AND MECHANICAL CHARACTERISTICS

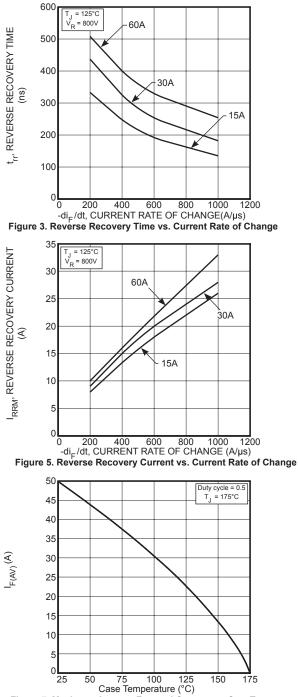
Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
R _{ØJC}	Junction-to-Case Thermal Resistance			.80	°C/W
W _T	Package Weight		0.07		οz
			9.9		g
Torque	Maximum Mounting Torque			10	lb•in
				1.1	N•m

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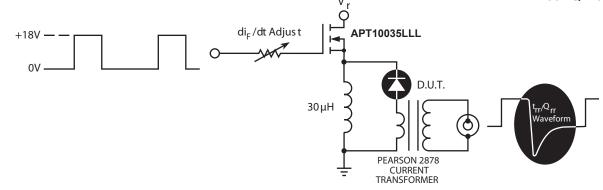
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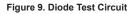




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Figure 7. Maximum Average Forward Current vs. CaseTemperature





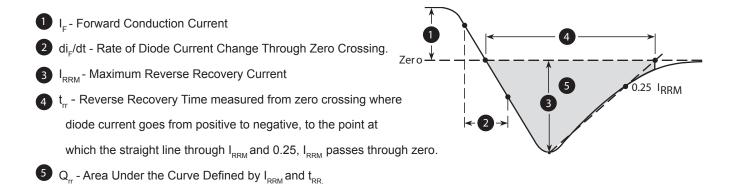
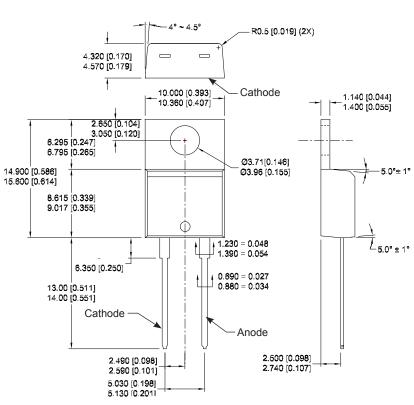


Figure 10. Diode Reverse Recovery Waveform Definition



TO-220 (K) Package Outline e3 100% Sn

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Dimensions in millimeters and [inches]

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